74AHC74; 74AHCT74

Dual D-type flip-flop with set and reset; positive-edge trigger

Rev. 7 — 21 April 2015

Product data sheet

1. General description

The 74AHC74; 74AHCT74 is a high-speed Si-gate CMOS device and is pin compatible with Low-Power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7-A.

The 74AHC74; 74AHCT74 is a dual positive-edge triggered, D-type flip-flop with individual data inputs (D), clock inputs (CP), set inputs (\overline{SD}) and reset inputs (\overline{RD}). It also has complementary outputs (Q and \overline{Q}).

The set and reset are asynchronous active LOW inputs that operate independent of the clock input. Information on the data input is transferred to the Q output on the LOW to HIGH transition of the clock pulse. The data inputs must be stable one set-up time prior to the LOW to HIGH clock transition for predictable operation.

Schmitt-trigger action in the clock input makes the circuit highly tolerant to slower clock rise and fall times.

2. Features and benefits

- Balanced propagation delays
- All inputs have Schmitt-trigger actions
- Inputs accept voltages higher than V_{CC}
- Input levels:
 - ◆ For 74AHC74: CMOS level
 - ◆ For 74AHCT74: TTL level
- ESD protection:
 - ◆ HBM EIA/JESD22-A114E exceeds 2000 V
 - ♦ MM EIA/JESD22-A115-A exceeds 200 V
 - ◆ CDM EIA/JESD22-C101C exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

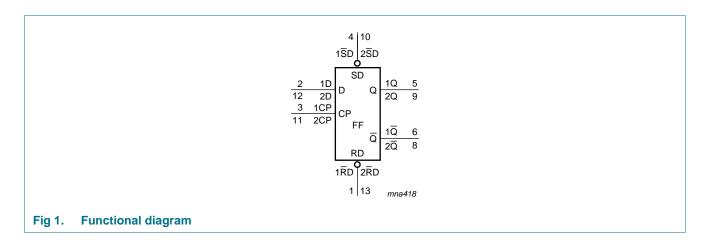


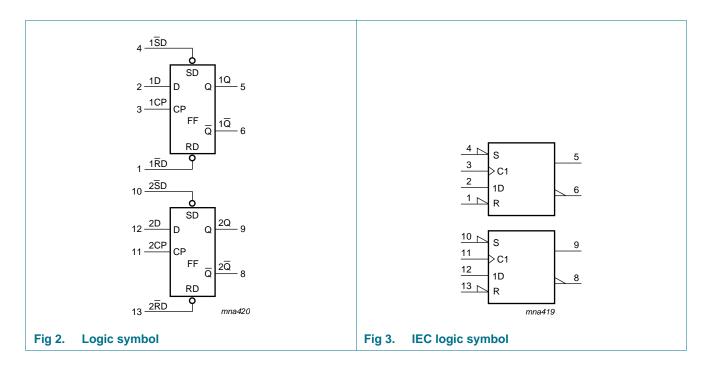
3. Ordering information

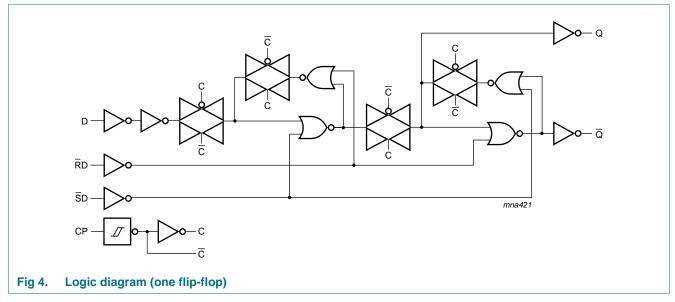
Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AHC74				
74AHC74D	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74AHC74PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74AHC74BQ	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1
74AHCT74				
74AHCT74D	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74AHCT74PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74AHCT74BQ	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 \times 3 \times 0.85 mm	SOT762-1

4. Functional diagram

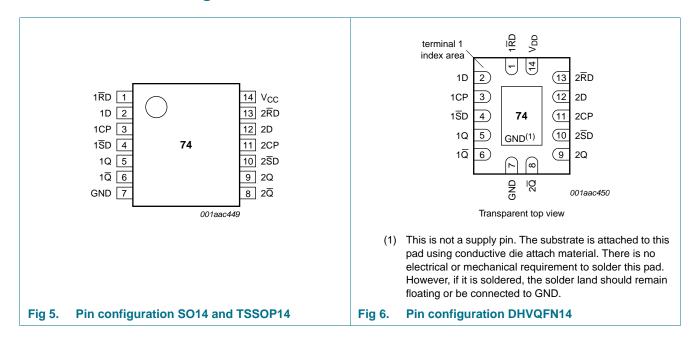






5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1RD	1	asynchronous reset direct input (active LOW)
1D	2	data input
1CP	3	clock input (LOW to HIGH, edge-triggered)
1SD	4	asynchronous set direct input (active LOW)
1Q	5	true flip-flop output
1Q	6	complement flip-flop output
GND	7	ground (0 V)
2Q	8	complement flip-flop output
2Q	9	true flip-flop output
2 S D	10	asynchronous set direct input (active LOW)
2CP	11	clock input (LOW to HIGH, edge-triggered)
2D	12	data input
2RD	13	asynchronous reset direct input (active LOW)
V _{CC}	14	supply voltage

6. Functional description

Table 3. Function table[1]

Control			Input	put Output								
nSD	nRD	nCP	nQ _{n+1}	nQ _{n+1}								
L	Н	X	X	Н	L	-	-					
Н	L	X	X	L	Н	-	-					
L	L	X	X	Н	Н	-	-					
Н	Н	1	L	-	-	L	Н					
Н	Н	↑	Н	-	-	Н	L					

[1] H = HIGH voltage level;

L = LOW voltage level;

 \uparrow = LOW to HIGH transition;

 Q_{n+1} = state after the next LOW to HIGH CP transition;

X = don't care.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V}$ [1]	-20	-	mA
I _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$ [1]	-20	+20	mA
Io	output current	$V_O = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$	-25	+25	mA
I _{CC}	supply current		-	+75	mA
I_{GND}	ground current		-75	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	-	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^[2] For SO14 packages: above 70 °C the value of P_{tot} derates linearly at 8 mW/K. For TSSOP14 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K. For DHVQFN14 packages: above 60 °C the value of P_{tot} derates linearly at 4.5 mW/K.

Recommended operating conditions

Table 5. **Operating conditions**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
74AHC7	4		-			
V _{CC}	supply voltage		2.0	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-	100	ns/V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	-	20	ns/V
74AHCT	74					
V _{CC}	supply voltage		4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	-	20	ns/V

Static characteristics

Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C	•	-40 °C t	o +85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74AHC7	4									
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
input voltag	input voltage	V _{CC} = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V _{CC} = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V _{CC} = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	$I_{O} = -50 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -50 \mu A; V_{CC} = 3.0 V$	2.9	3.0	-	2.9	-	2.9	-	V
		$I_{O} = -50 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_{O} = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	$I_O = 50 \mu A; V_{CC} = 2.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A; V_{CC} = 3.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_O = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V

 Table 6.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C 1	to +85 °C	-40 °C to	Unit	
			Min	Тур	Max	Min	Max	Min	Max	
l _l	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	2.0	-	20	-	40	μΑ
C _I	input capacitance	$V_I = V_{CC}$ or GND	-	3	10	-	10	-	10	pF
74AHCT	HCT74								-	
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -8.0 \text{ mA}$	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
II	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	2.0	-	20	-	40	μΑ
Δl _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other pins at V_{CC} or GND; $I_O = 0 \text{ A}$; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
Cı	input $V_I = V_{CC}$ or GND capacitance		-	3	10	-	10	-	10	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit, see Figure 9.

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
74AHC7	4									
t _{pd}	propagation	nCP to nQ, nQ; see Figure 7 [2]								
	delay	V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	5.2	11.9	1.0	14.0	1.0	15.0	ns
		C _L = 50 pF	-	7.4	15.4	1.0	17.5	1.0	19.5	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	3.7	7.3	1.0	8.5	1.0	9.5	ns
		C _L = 50 pF	-	5.2	9.3	1.0	10.5	1.0	12.0	ns
		nSD, nRD to nQ, nQ; see Figure 8								
		V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	5.4	12.3	1.0	14.5	1.0	15.5	ns
		C _L = 50 pF	-	7.7	15.8	1.0	18.0	1.0	20.0	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	3.7	7.7	1.0	9.0	1.0	10.0	ns
		C _L = 50 pF	-	5.3	9.7	1.0	11.0	1.0	12.5	ns
f _{max}	maximum	see Figure 7								
	frequency	V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	80	125	-	70	-	70	-	MHz
		C _L = 50 pF	50	75	-	45	-	45	-	MHz
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	130	170	-	110	-	110	-	MHz
		C _L = 50 pF	90	115	-	75	-	75	-	MHz
t _W	pulse width	CP HIGH or LOW; nSD, nRD LOW; see Figure 7 and 8								
		V _{CC} = 3.0 V to 3.6 V	6.0	-	-	7.0	-	7.0	-	ns
		V _{CC} = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.0	-	ns
t _{su}	set-up time	nD to nCP; see Figure 7								
		V _{CC} = 3.0 V to 3.6 V	6.0	-	-	7.0	-	7.0	-	ns
		V _{CC} = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.0	-	ns
t _h	hold time	nD to nCP; see Figure 7								
		V _{CC} = 3.0 V to 3.6 V	0.5	-	-	0.5	-	0.5	-	ns
		V _{CC} = 4.5 V to 5.5 V	0.5	-	-	0.5	-	0.5	-	ns
t _{rec}	recovery	nRD to nCP; see Figure 8								
	time	V _{CC} = 3.0 V to 3.6 V	5.0	-	-	5.0	-	5.0	-	ns
		V _{CC} = 4.5 V to 5.5 V	3.0	-	-	3.0	-	3.0	-	ns

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit, see Figure 9.

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	1.0 10.0		
			Min	Typ[1]	Max	Min	Max	Min	Max		
C_{PD}	power dissipation capacitance	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$ [3]	-	12	-	-	-	-	-	pF	
74AHCT	74; V _{CC} = 4.5	V to 5.5 V									
t _{pd}		nCP to nQ, nQ; see Figure 7 [2]								T	
	delay	C _L = 15 pF	-	3.3	7.8	1.0	9.0	1.0	10.0	ns	
		C _L = 50 pF	-	4.8	8.8	1.0	10.0	1.0	11.0	ns	
		nSD, nRD to nQ, nQ; see Figure 7									
		C _L = 15 pF	-	3.7	10.4	1.0	12.0	1.0	13.0	ns	
		C _L = 50 pF	-	5.3	11.4	1.0	13.0	1.0	14.5	ns	
f _{max}	maximum	see Figure 7									
	frequency	C _L = 15 pF	100	160	-	80	-	80	-	MHz	
		C _L = 50 pF	80	140	-	65	-	65	-	MHz	
t _W	pulse width	CP HIGH or LOW; nSD, nRD LOW; see Figure 7 and 8	5.0	-	-	5.0	-	5.0	-	ns	
t _{su}	set-up time	nD to nCP; see Figure 7	5.0	-	-	5.0	-	5.0	-	ns	
t _h	hold time	nD to nCP; see Figure 7	0	-	-	0	-	0	-	ns	
t _{rec}	recovery time	nRD to nCP; see Figure 8	3.5	-	-	3.5	-	3.5	-	ns	
C_{PD}	power dissipation capacitance	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$ 3	-	16	-	-	-	-	-	pF	

- [1] Typical values are measured at nominal supply voltage ($V_{CC} = 3.3 \text{ V}$ and $V_{CC} = 5.0 \text{ V}$).
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$$
 where:

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

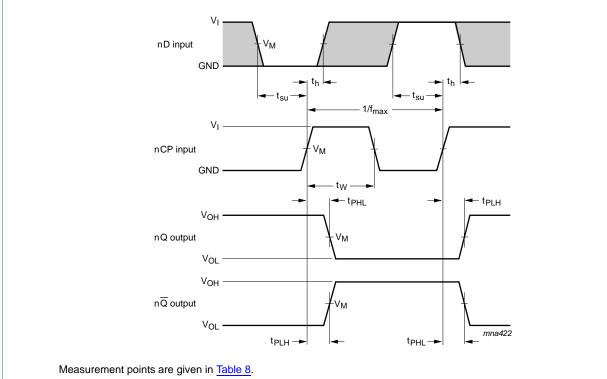
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

11. Waveforms



The shaded areas indicate when the input is permitted to change for predictable output performance.

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 7. Clock pulse width, maximum frequency, set-up times, hold times and input to output propagation delays

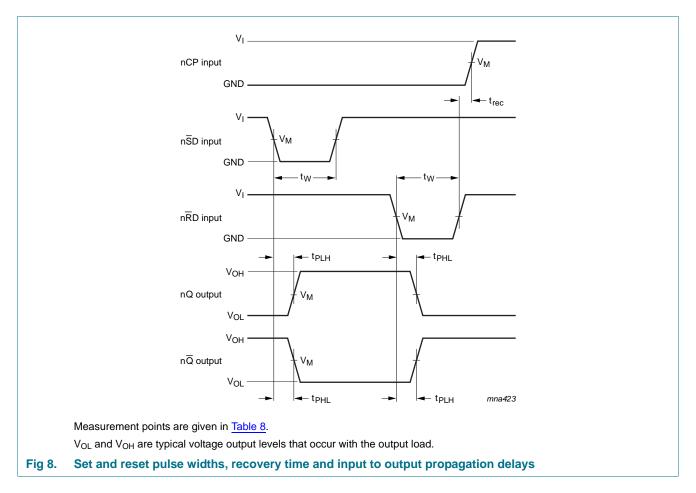
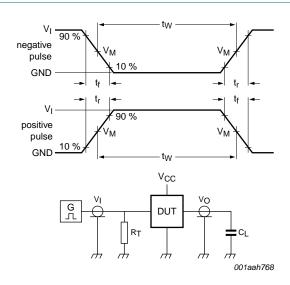


Table 8. Measurement points

Туре	Input	Output
	V _M	V _M
74AHC74	0.5 × V _{CC}	$0.5 \times V_{CC}$
74AHCT74	1.5 V	$0.5 \times V_{CC}$



For test data, see Table 9.

Definitions for test circuit:

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

Fig 9. Load circuitry for switching times

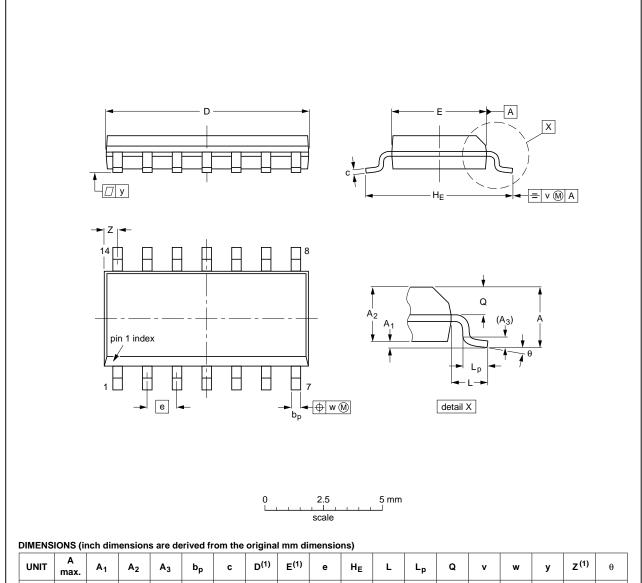
Table 9. Test data

Туре	Input		Load	Test
	VI	t _r , t _f	CL	
74AHC74	V _{CC}	≤ 3.0 ns	50 pF, 15 pF	t _{PLH} , t _{PHL}
74AHCT74	3.0 V	≤ 3.0 ns	50 pF, 15 pF	t _{PLH} , t _{PHL}

12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



UNIT	A max.	A ₁	A ₂	A ₃	b _p	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE
SOT108-1	076E06	MS-012				99-12-27 03-02-19

Fig 10. Package outline SOT108-1 (SO14)

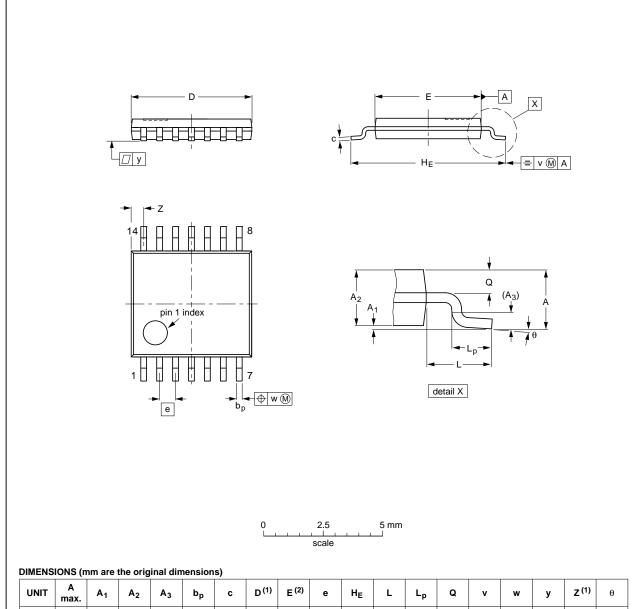
74AHC_AHCT74

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



Ξ					,		-,												
	UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
	mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT402-1		MO-153				99-12-27 03-02-18	

Fig 11. Package outline SOT402-1 (TSSOP14)

74AHC_AHCT74

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

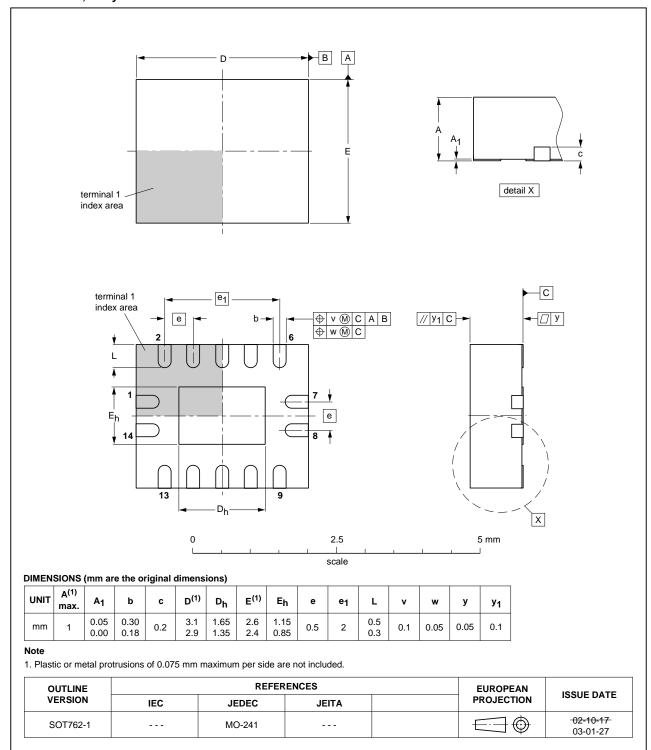


Fig 12. Package outline SOT762-1 (DHVQFN14)

74AHC_AHCT74

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13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
ESD	ElectroStatic Discharge
HBM	Human Body Model
LSTTL	Low-power Schottky Transistor-Transistor Logic
MM	Machine Model

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC_AHCT74 v.7	20150421	Product data sheet	-	74AHC_AHCT74 v.6
Modifications:	• <u>Table 7</u> : mi	nimum f _{max} values at 3.0 V to	3.6 V for 74AHC	74 corrected (errata).
74AHC_AHCT74 v.6	20141020	Product data sheet	-	74AHC_AHCT74 v.5
Modifications:	• <u>Table 3</u> corr	ected (errata).		
74AHC_AHCT74 v.5	20080609	Product data sheet	-	74AHC_AHCT74 v.4
Modifications:		of this data sheet has been red of NXP Semiconductors.	esigned to comply v	vith the new identity
	 Legal texts 	have been adapted to the new	company name whe	ere appropriate.
	Table 6: the	conditions for input leakage cu	rrent have been cha	anged.
74AHC_AHCT74 v.4	20050207	Product data sheet	-	74AHC_AHCT74 v.3
74AHC_AHCT74 v.3	20040429	Product specification	-	74AHC_AHCT74 v.2
74AHC_AHCT74 v.2	19990923	Product specification	-	74AHC_AHCT74 v.1
74AHC_AHCT74 v.1	19990805	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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16. Contact information

For more information, please visit: http://www.nexperia.com

For sales office addresses, please send an email to: salesaddresses@nexperia.com

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